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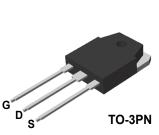
FQA11N90C-F109 N-Channel QFET[®] MOSFET 900 V, 11.0 A, 1.1 Ω

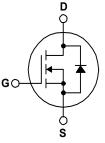
Features

- + 11 A, 900 V, $R_{DS(on)}$ = 1.1 Ω (Max.) @ V_{GS} = 10 V, I_D = 5.5 A
- Low Gate Charge (Typ. 60 nC)
- Low Crss (Typ. 23 pF)
- 100% Avalanche Tested
- RoHS compliant

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and elec-tronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter Drain to Source Voltage			FQA11N90C_F109	Unit V
V _{DSS}				900	
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		11.0	A
	Drain Current	- Continuous (T _C = 100 ^o C)		6.9	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	44.0	A
V _{GSS}	Gate to Source Voltage			± 30	V
E _{AS}	Single Pulsed Avalanche	e Energy	(Note 2)	960	mJ
I _{AR}	Avalanche Current		(Note 1)	11.0	A
E _{AR}	Repetitive Avalanche Er	nergy	(Note 1)	30	mJ
dv/dt	Peak Diode Recovery d	v/dt	(Note 3)	4.0	V/ns
P _D	Dower Dissinction	(T _C = 25 ^o C)		300	W
	Power Dissipation	- Derate Above 25 ^o C		2.38	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
Τ _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C

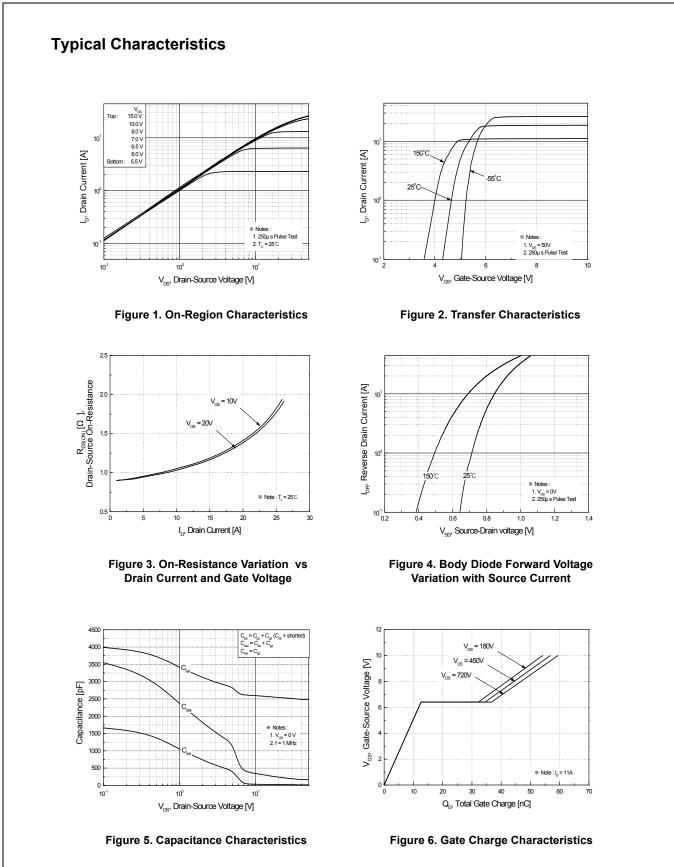
Thermal Characteristics

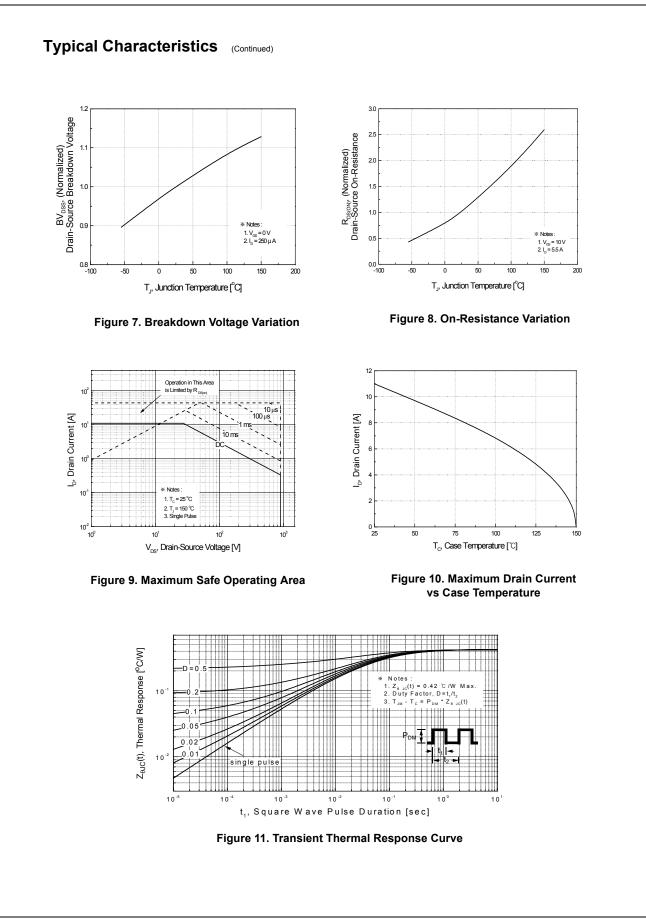
Symbol	Parameter	FQA11N90C_F109	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	0.42	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max	40	°C/W

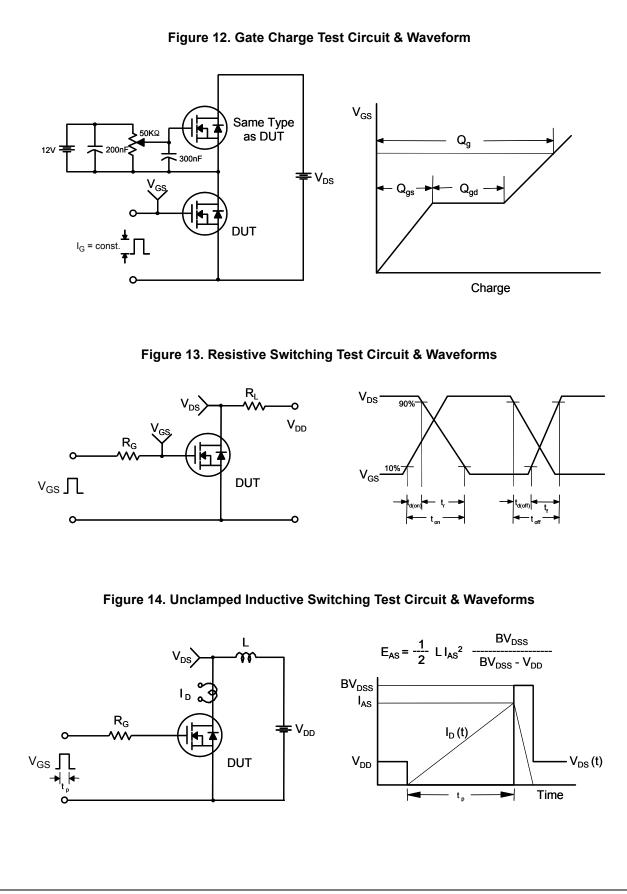
Part Number Top Mark		Top Mark	Package	Packing Method	Reel S	ize	Tape Wi	dth	Quantit
FQA11N90C-F109 FQA11N90C		TO-3PN				N/A		30 units	
lectri	cal Chara	cteristics T _C = 25°C	C unless othe	rwise noted.					
Symbol		Parameter		Test Conditions		Min	Тур	Max	Unit
		_							
	aracteristics		V _{GS} = 0 V, I _D = 250 μA			000	1		
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 ν, I _D = 250 μA		900			V	
∆BV _{DSS} ∆TJ	Breakdown Voltage Temperature Coefficient		I _D = 250 μ/	I_D = 250 µA, Referenced to 25°C			1.02		V/°C
1	Zero Gate Voltage Drain Current		V _{DS} = 900 V, V _{GS} = 0 V				10	μA	
DSS			V _{DS} = 720 V, T _C = 125°C					100	μA
GSSF	Gate-Body L	eakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V				100	nA	
GSSR	Gate-Body L	eakage Current, Reverse	everse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$					-100	nA
On Cha	racteristics	S							
/ _{GS(th)}	Gate Thresh		V _{DS} = V _{GS} , I _D = 250 μA			3.0		5.0	V
R _{DS(on)}	Static Drain-S		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$			0.91	1.1	Ω	
FS		nsconductance	V _{DS} = 50 V	/, I _D = 5.5 A			9.0		S
	ic Characte		1				T		1
liss	Input Capaci		V _{DS} = 25 V	/, V _{GS} = 0 V,			2530	3290	pF
oss	Output Capa		f = 1.0 MH	Z			215	280	pF
Srss	Reverse Trai	nsfer Capacitance					23	30	pF
Switchi	ing Charac	teristics							
d(on)	Turn-On Dela		V = 450	V _{DD} = 450 V, I _D = 11.0 A,			60	130	ns
r	Turn-On Rise	e Time	$R_{G} = 25 \Omega$				130	270	ns
d(off)	Turn-Off Dela	ay Time	- NG 2012				130	270	ns
;	Turn-Off Fall	Time			(Note 4)		85	180	ns
λ ^g	Total Gate C	harge	V _{DS} = 720	V, I _D = 11.0 A,			60	80	nC
ک _{gs}	Gate-Source	Charge	V _{GS} = 10 V	V _{GS} = 10 V			13		nC
λ ^{gd}	Gate-Drain C	Charge			(Note 4)		25		nC
									-
Srain-S		le Characteristics a		•				11.0	A
SM	Maximum Continuous Drain-Source Diode Forward Current Maximum Pulsed Drain-Source Diode Forward Current					44.0	A		
SM SD		Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 11.0 A$				1.4	V	
r SD	Reverse Rec	0		-			1000		ns
n D ^{uu}		covery Charge	V _{GS} = 0 V, I _S = 11.0 A, dI _F / dt = 100 A/μs			17.0		μC	
1 1	INCICISE INCO	overy onlarge					17.0		μΟ

FQA11N90C-F109 — N-Channel QFET[®] MOSFET

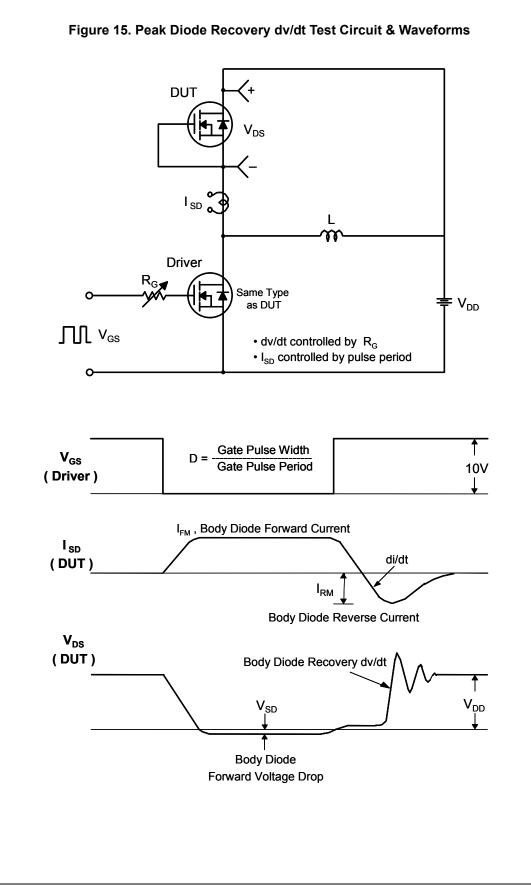
4. Essentially independent of operating temperature.

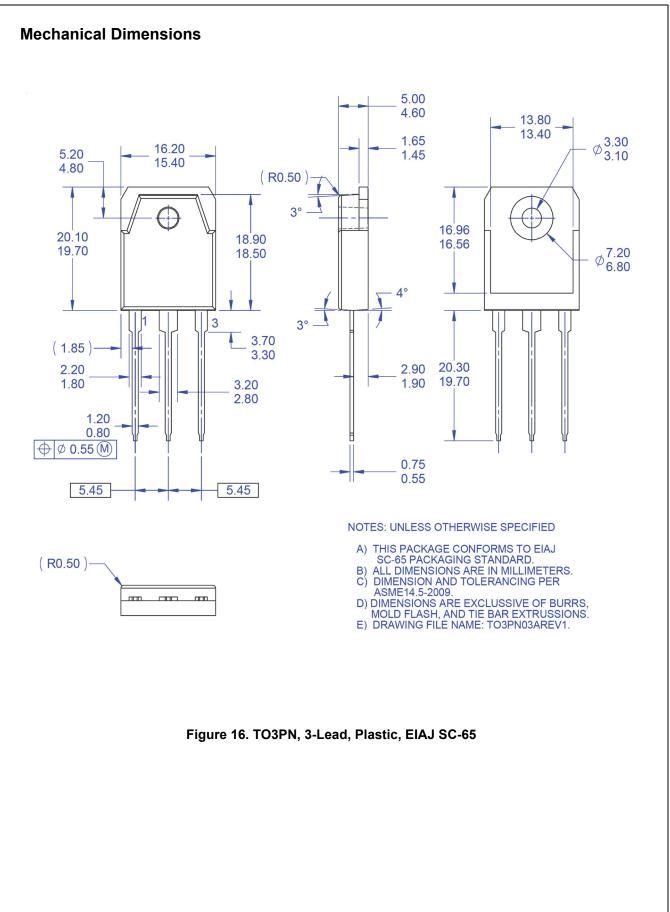






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